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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/519,700	09/14/2005	Wade A. Krull	211843-00030	6925
27160 7590 04/02/2009 KATTEN MUCHIN ROSENMAN LLP (C/O PATENT ADMINISTRATOR) 2900 K STREET NW, SUITE 200 WASHINGTON, DC 20007-5118				
EXAMINER				
ANGADI, MAKI A				
ART UNIT		PAPER NUMBER		
1792				
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**Please find below and/or attached an Office communication concerning this application or proceeding.**

The time period for reply, if any, is set in the attached communication.

### Office Action Summary

**Application No.**

10/519,700

**Applicant(s)**

KRULL ET AL.

**Examiner**

MAKI A. ANGADI

**Art Unit**

1792

**Period for Reply** -- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

**Status**

- 1) ☒ Responsive to communication(s) filed on 04 February 2009.
- 2a) ☒ This action is **FINAL**. 2b) ☐ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

**Disposition of Claims**

- 4) ☒ Claim(s) 1-23 and 26-30 is/are pending in the application.
- 4a) Of the above claim(s) \_\_\_\_\_ is/are withdrawn from consideration.
- 5) ☒ Claim(s) 1-23 is/are allowed.
- 6) ☒ Claim(s) 26-30 is/are rejected.
- 7) ☐ Claim(s) \_\_\_\_\_ is/are objected to.
- 8) ☐ Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

**Application Papers**

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on \_\_\_\_\_ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
- Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
- Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

**Priority under 35 U.S.C. § 119**

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some \* c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
  2. ☐ Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.
  3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

\* See the attached detailed Office action for a list of the certified copies not received.

**Attachment(s)**

- 1) ☐ Notice of References Cited (PTO-892)
- 2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948)
- 3) ☐ Information Disclosure Statement(s) (PTO-8508)
- Paper No(s)/Mail Date \_\_\_\_\_

- 4) ☐ Interview Summary (PTO-413)
- Paper No(s)/Mail Date \_\_\_\_\_
- 5) ☐ Notice of Informal Patent Application
- 6) ☐ Other: \_\_\_\_\_

**DETAILED ACTION**

***Claim Rejections - 35 USC § 112***

1. Rejection of claims 1-30 under 35 U.S.C. 112 second paragraph is withdrawn in view of the amendment to claims 1, 2, 11, 17 and 19 and cancellation of claim 24.

***Claim Rejections - 35 USC § 112***

The following is a quotation of the first paragraph of 35 U.S.C. 112:

The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.

Claims 26-30 are rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. The claim(s) contains subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention.

With respect to claim 26, applicants' use of the term "first dopant type" in steps (b) and (c) for implanting dielectric layer is not fully supported in the written description.

***Claim Rejections - 35 USC § 112***

The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

Claims 26-30 rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

With respect to claim 26, applicants' use of the phrase "type" renders claim indefinite because it does not disclose what specific species the group of dopant types belong to.

***Claim Rejections - 35 USC § 102***

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(b) The invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

**2. Claims 26 and 29-30, are rejected under 35 U.S.C. 102(b) as anticipated by or, in the alternative, under 35 U.S.C. 103(a) as obvious over Tokuyama et al. (US Patent No. 3,607,449).**

Tokuyama discloses a process for forming a shallow or minute junction in a semiconductor N-type silicon substrate(10) as a semiconductor device (PN junction) (Fig. 4-9, Examples 1-2, col.2, lines 44-72, col.3, lines 8-35), the process comprising the steps of: (a) depositing a dielectric layer (11) (SiO layer) on a substrate (10) (b) doping dielectric layer (col.2, lines 55-58) with boron ions at an implant energy such that the dopant is contained within the dielectric layer (col.2, lines 61-64) (c) providing heat treatment up to about 1000°C to diffuse

boron ions in the dielectric layer to diffuse into the substrate to form a shallow junction (col.2, lines 63-67) (claim 1).

Tokuyama further teaches that the penetration of the boron ions into the thin dielectric oxide layer is determined and/or controlled by the ion beam energy (See Fig. 4 and Col. 2, lines 53-64). The reference further teaches that the extent of the diffusion of the ions stored in the dielectric layer into the semiconductor substrate or the depth of the junction on the substrate is a function of the quantity of the boron ions stored in the dielectric oxide layer and the duration of the heat treatment. See col. 3 lines 63-72. Therefore, in view of the teaching of Tokuyama, it would have been obvious to one having ordinary skill in the art to use low ion beam energy for implanting a small amount of boron ions within the dielectric layer and to reduce the time of the heat treatment in order to diffuse this small amount of boron ions in the oxide dielectric layer into the substrate to finally to produce an shallow junction in the semiconductor substrate

***Claim Rejections - 35 USC § 103***

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

**3. Claim 26 is rejected under 35 U.S.C. 103(a) as obvious over Tokuyama et al. (US Patent No. 3,607,449) in view of Lee (US Patent No. 5,777,337).**

Tokuyama discloses a single ion implant (Example 1 and 2) but is silent about series of ion implants in the fabrication of a semiconductor device. However, Lee discloses a series of ion implants i.e. boron ion implant (col.2, lines 58-61 followed by arsenic doping (col.2 lines 62-65). Therefore, it would have been obvious to one of ordinary skill in the art at the time of the invention to implement series of ion implants of the same dopant type or of different dopant type in the fabrication of a semiconductor device because Lee illustrates that shallow junctions can be formed by a series of ion implantation to minimize junction leakage current and to improve reliability of junction devices (col.2, lines 1-4).

**4. Claim 27 is rejected under 35 U.S.C. 103(a) over Tokuyama et al. (US Patent No. 3,607,449) as applied to claim 26 above, in further view of Mannino, *Nuclear Instruments and Methods in Physics Research B186, (2002) pages 246-255*.**

Tokuyama fails to disclose doping of boron clusters in the source/drain regions. However, Mannino discloses the advantage of doping boron clusters by ion implantation in the formation of shallow junctions (page 247, col.1). Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to select boron clusters for doping source/drain

regions because Mannino illustrates that doping of boron clusters lead to the realization of ultra-shallow p+ source/drain structures within 100 nm from the surface (page 247).

**5. Claim 28 is rejected under 35 U.S.C. 103(a) over Tokuyama et al. (US Patent No. 3,607,449) and Lee (US Patent No. 5,777,337) as applied to claim 26 above, in further view of Marinskiy, Materials Research Society Symposium Proceedings, Vol.669, (2001), page J2.5.1-J2.5.6.**

Lee discloses doping boron into the dielectric layer but fails to disclose doping boron implant followed by hydrogen. However, Marinskiy studies the passivation of boron by hydrogen in silicon IC fabrication (page J2.5.1). Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify boron doping with hydrogen because Marinskiy illustrates the passivation of boron by hydrogen introduced into Si during typical surface treatment used in IC fabrication.

***Allowable Subject Matter***

6. Claims 1-23 are allowed.

The following is a statement of reasons for the indication of allowable subject matter: The closest prior art of Lin (US Patent No. 6,069,061) fails to disclose a method for forming a gate electrode for a metal oxide semiconductor device with the sequence of steps as defined in applicants' amended independent claims 1, 11, 17 and 19.

***Response to Arguments***

7. Applicant's arguments filed 2/4/2009 have been fully considered but they are not persuasive.

Applicants' arguments on page 9 of the reply asserting that the second reference of Lee teaches different type of implants i.e. p-type and n-type dopants are not convincing. Lee teaches doping dielectric layer with either boron or arsenic dopants. One who is skilled in the art should be able to use multiple dopants of the same type to form ultra-shallow junction of semiconductor device. Applicants' amendment to claim 26 requiring multiple dopant of the same dopant type is not supported in the specification.

***Conclusion***

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will



the statutory period for reply expire later than SIX MONTHS from the date of this final action.

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Aronowitz (US Patent No. 5,837,598) discloses diffusion barrier for polysilicon gate electrode of MOS device.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Maki A. Angadi whose telephone number is 571-272-8213. The examiner can normally be reached on 8 AM to 4.30 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nadine G. Norton can be reached on 571-272-1465. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Art Unit: 1792

/Maki A Angadi/  
Examiner, Art Unit 1792

/Nadine G Norton/  
Supervisory Patent Examiner, Art Unit 1792